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Thermal Conductivity Measurement of Two Paperboard Materials

by

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to

Department of The Army
Office of The Quartermaster General
Washington 25, D.C.

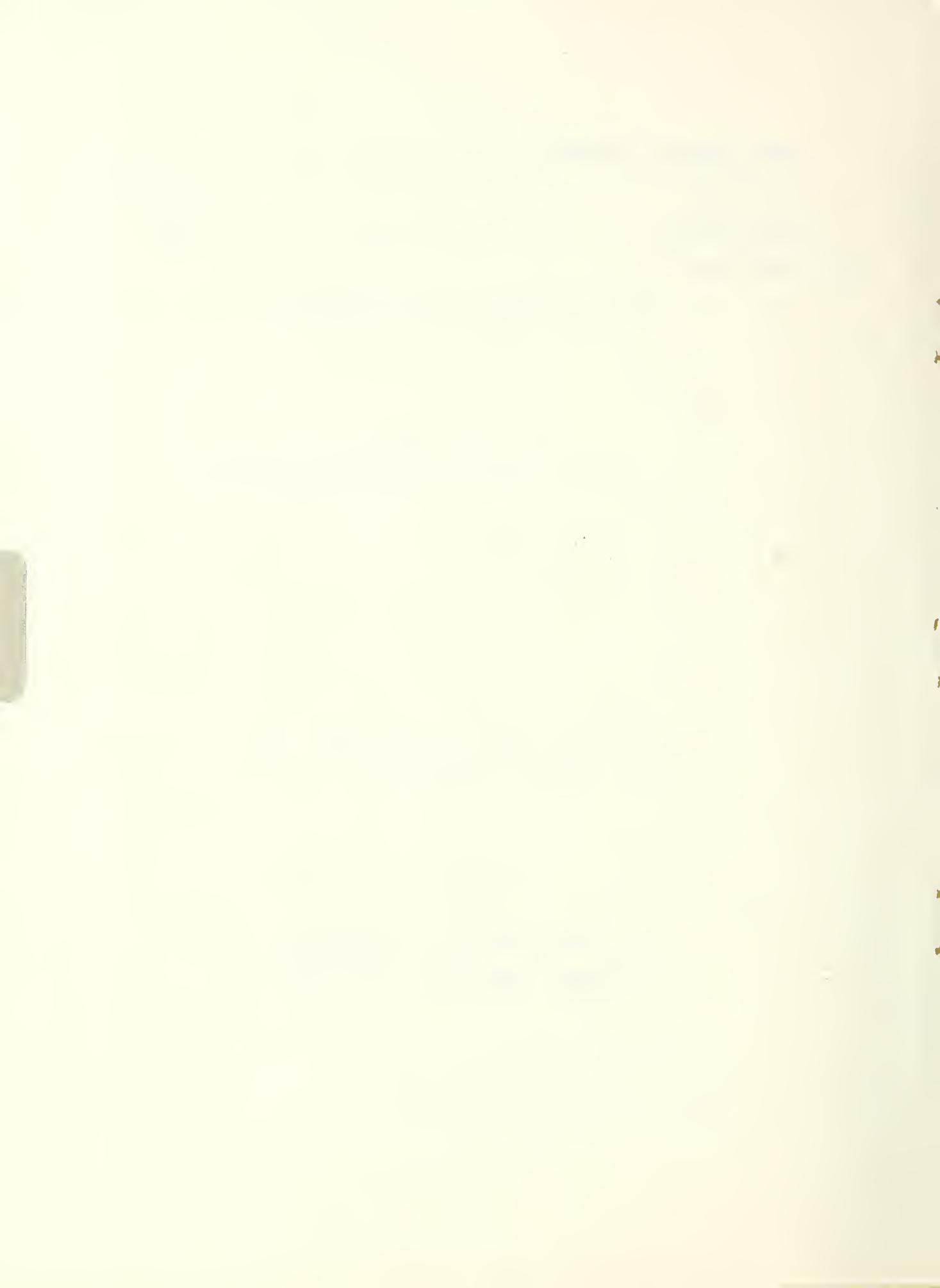


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1. INTRODUCTION.

At the request of the Office of the Quartermaster General, reference File Quay 400.112, letter dated March 15, 1951, thermal conductivity measurements were made on two paperboard materials to determine their insulation value.

2. MATERIALS.

Specimen	Description
1 Two 6x6 inch specimens each consisting of 11 layers of paperboard. Average thickness of paperboard 0.002 inch.	Paperboard material manufactured by Imperial Container Corporation, St. Louis, Mo.
2 Two 6x6 inch specimens each consisting of 10 pieces of paperboard. Average thickness of paperboard 0.107 inch.	Paperboard material manufactured by the Container Corporation of America, Chicago, Ill.

3. TEST METHODS.

The thermal conductivity of the specimens was measured in an 8-inch square hot-plate apparatus conforming with the requirements of Test Spec. MIL-T-3216 and of MIL-C-177-65.

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specimens were made by filling two or even three plies of the paperboard material to obtain a thickness of approximately one inch. The material was treated as received without drying. In the case of sample No. 2, the naked surface of the paperboard faced the cold plate during the test. It was never covered on any of the faces of sample No. 1.

4. Results

A summary of the test data is given in Table I and a plot of thermal conductivity versus temperature is shown in Fig. 1. Due to the low temperatures at which a condensation point is about $40^{\circ}F$, extrapolation of the data by drawing lines to lower temperatures involves some approximation. However, it is believed that within the accuracy required for practical purposes, such extrapolation would be permissible.

TABLE I

Specimen	Resin temp. of spec. °F	Density as tested lb/ft ³	Thickness as tested inch	Temp. gradient in spec. deg F/inch	Material conductivity btu/hr ft ² (deg F/inch)	Total conductance of one pl. ftm/hr °F (deg F)
1 (21 plies)	69.9	43.1	0.977	43.2	0.560	6.31
	40.4	43.1		.978	43.0	.530
2 (10 plies)	70.0	46.9		.997	44.3	.625
	40.8	46.9		.997	42.2	.593
						5.95

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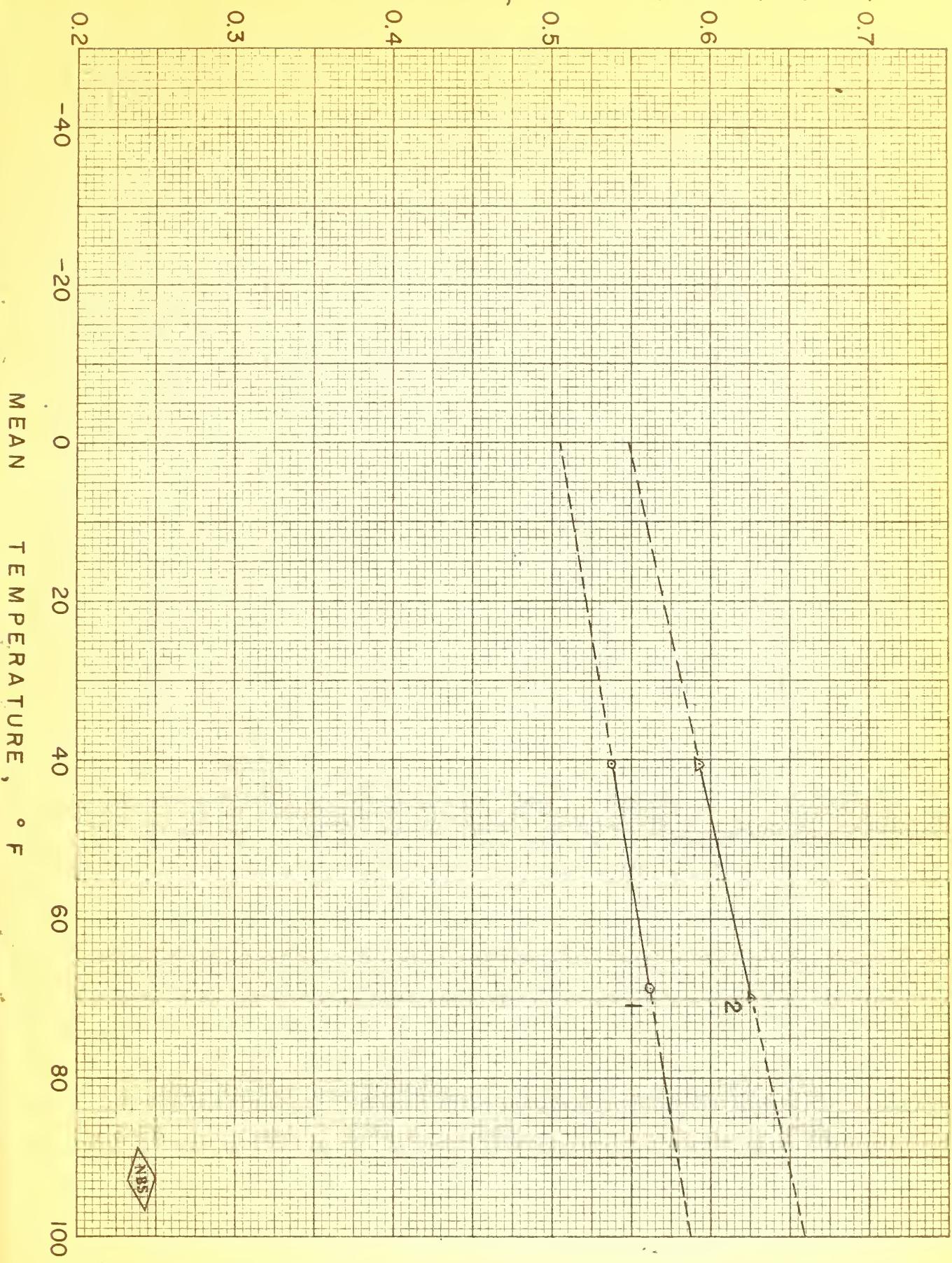
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THERMAL CONDUCTIVITY, BTU / HR - FT² (DEG F / IN)



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FIGURE 1

